IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

First Named Inventor: KAWATE, KOHICHIRO

Application No.: 10/517,670   Confirmation No.: 1922

Filed: June 23, 2003

Title: HEAT CURABLE ADHESIVE COMPOSITION, ARTICLE, SEMICONDUCTOR APPARATUS AND METHOD

AMENDMENT AND RESPONSE UNDER 37 CFR § 1.111

Mail Stop Amendment
Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

Dear Sir:

Applicants submit this Amendment and response in reply to the outstanding Office Action dated April 30, 2007 in the above-identified application.

Amendments to the Specification begin on page 4 of this paper.

Amendments to the Claims begin on page 6 of this paper.

Remarks/Arguments begin on page 9 of this paper.

Fees

Applicants will submit payment of any fee required for submission of this paper at the time of its submission via EFS-Web. In the event fees are not or cannot be paid at the time of EFS-Web submission, please charge any fees required under 37 C.F.R. § 1.17 to Deposit Account No. 13-3723 together with any additional fees associated with the prosecution of this application. This authorization includes the fee for any necessary extension of time under 37 CFR § 1.136(a). To the extent any such extension should become necessary, it is hereby requested. Please credit any overpayment to the same deposit account.

Applicants calculate additional claim fees for this amendment as follows:

Claims As Amended							
(1)	(2) Claims Remaining After Amendment	(3)	(4) Highest No. Previously Paid For		(5) Present Extra	(6) Rate	(7) Additional Fee
Total Claims	14	Minus	**	20	0	x $50.00	$0.00
Independent Claims	4	Minus	***	4	0	x $200.00	$0.00
Additional fee for filing one or more multiple dependent claims, if no such fee has been paid						$360.00	
Total Additional Fee For This Amendment							$0.00
** If the "Highest No. Previously Paid For" is less than 20, insert "20" in next space. *** If the "Highest No. previously Paid For" is less than 3, insert "3" in next space.							